

N-Channel 20-V (D-S) Fast Switching MOSFET

PRODUCT SUMMARY

| V_{DS} (V) | $R_{DS(on)}$ (Ω) | I_D (A) |
|--------------|----------------------------|-----------|
| 20 | 0.0065 at $V_{GS} = 4.5$ V | 22 |
| | 0.009 at $V_{GS} = 2.5$ V | 19 |

FEATURES

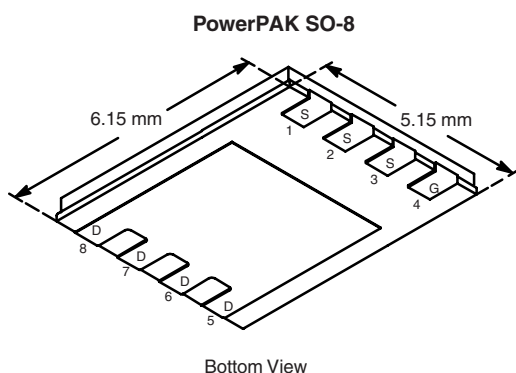
- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET
- New Low Thermal Resistance PowerPAK® Package with Low 1.07 mm Profile
- 100 % R_g Tested



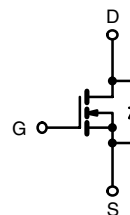
RoHS
COMPLIANT
HALOGEN
FREE
Available

APPLICATIONS

- Synchronous Rectifier Low Output Voltage
- Portable Computer Battery Selection or Protection



Ordering Information: Si7448DP-T1-E3 (Lead (Pb)-free)
Si7448DP-T1-GE3 (Lead (Pb)-free and Halogen-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_A = 25^\circ\text{C}$, unless otherwise noted

| Parameter | | Symbol | 10 s | Steady State | Unit |
|--|-----------------------|-----------------------------------|-------------|--------------|------|
| Drain-Source Voltage | | V _{DS} | 20 | | V |
| Gate-Source Voltage | | V _{GS} | ± 12 | | |
| Continuous Drain Current (T _J = 150°C) ^a | T _A = 25°C | I _D | 22 | 13.4 | A |
| | T _A = 70°C | | 17.6 | 10.7 | |
| Pulsed Drain Current | | I _{DM} | 50 | | |
| Continuous Source Current (Diode Conduction) ^a | | I _S | 4.3 | 1.6 | |
| Maximum Power Dissipation ^a | T _A = 25°C | P _D | 5.2 | 1.9 | W |
| | T _A = 70°C | | 3.3 | 1.2 | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 150 | | °C |
| Soldering Recommendations (Peak Temperature) ^{b, c} | | | 260 | | |

THERMAL RESISTANCE RATINGS

| Parameter | | Symbol | Typical | Maximum | Unit |
|--|---------------|------------|---------|---------|--------------------|
| Maximum Junction-to-Ambient ^a | $t \leq 10$ s | R_{thJA} | 19 | 24 | $^\circ\text{C/W}$ |
| | Steady State | | 52 | 65 | |
| Maximum Junction-to-Case (Drain) | Steady State | R_{thJC} | 1.5 | 1.8 | |

Notes

- Surface Mounted on 1" x 1" FR4 board.
- See Solder Profile (www.vishay.com/ppg?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

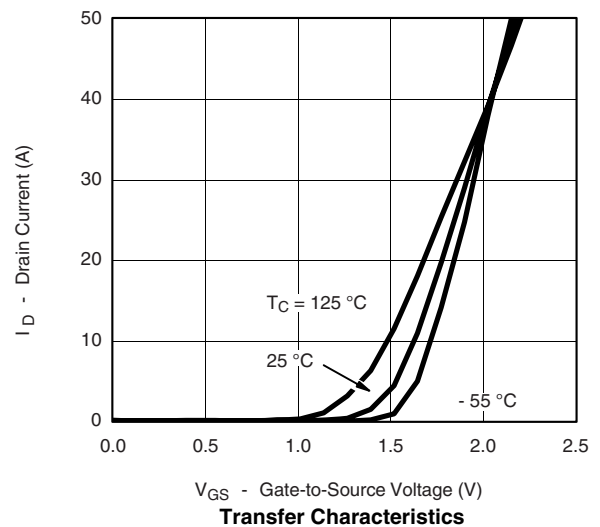
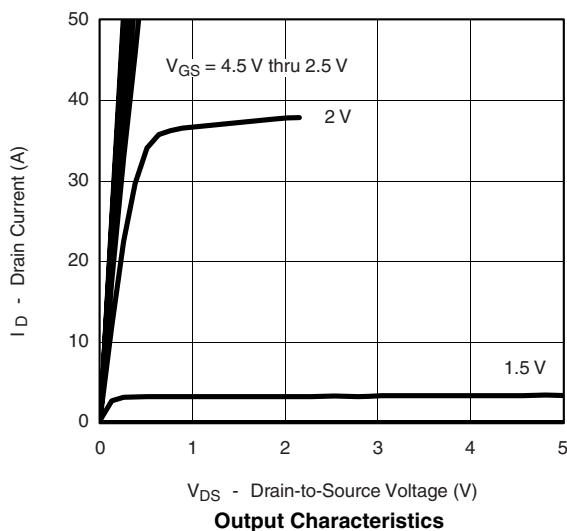
| MOSFET SPECIFICATIONS $T_J = 25^\circ\text{C}$, unless otherwise noted | | | | | | |
|---|--------------|--|------|--------|-----------|---------------|
| Parameter | Symbol | Test Conditions | Min. | Typ. | Max. | Unit |
| Static | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS} = V_{GS}$, $I_D = 250\ \mu\text{A}$ | 0.6 | | 1.5 | V |
| Gate-Body Leakage | I_{GSS} | $V_{DS} = 0\ \text{V}$, $V_{GS} = \pm 12\ \text{V}$ | | | ± 100 | nA |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS} = 20\ \text{V}$, $V_{GS} = 0\ \text{V}$ | | | 1 | μA |
| | | $V_{DS} = 20\ \text{V}$, $V_{GS} = 0\ \text{V}$, $T_J = 85^\circ\text{C}$ | | | 20 | |
| On-State Drain Current ^a | $I_{D(on)}$ | $V_{DS} \geq 5\ \text{V}$, $V_{GS} = 4.5\ \text{V}$ | 50 | | | A |
| Drain-Source On-State Resistance ^a | $R_{DS(on)}$ | $V_{GS} = 4.5\ \text{V}$, $I_D = 22\ \text{A}$ | | 0.0054 | 0.0065 | Ω |
| | | $V_{GS} = 2.5\ \text{V}$, $I_D = 19\ \text{A}$ | | 0.0075 | 0.009 | |
| Forward Transconductance ^a | g_{fs} | $V_{DS} = 15\ \text{V}$, $I_D = 22\ \text{A}$ | | 90 | | S |
| Diode Forward Voltage ^a | V_{SD} | $I_S = 3\ \text{A}$, $V_{GS} = 0\ \text{V}$ | | 0.8 | 1.2 | V |
| Dynamic^b | | | | | | |
| Total Gate Charge | Q_g | $V_{DS} = 10\ \text{V}$, $V_{GS} = 4.5\ \text{V}$, $I_D = 21\ \text{A}$ | | 38 | 50 | nC |
| Gate-Source Charge | Q_{gs} | | | 8 | | |
| Gate-Drain Charge | Q_{gd} | | | 8.5 | | |
| Gate Resistance | R_g | | 0.2 | 0.9 | 1.1 | Ω |
| Turn-On Delay Time | $t_{d(on)}$ | $V_{DD} = 10\ \text{V}$, $R_L = 10\ \Omega$ $I_D \approx 1.0\ \text{A}$, $V_{GEN} = 10\ \text{V}$, $R_g = 6\ \Omega$ | | 22 | 35 | ns |
| Rise Time | t_r | | | 22 | 35 | |
| Turn-Off Delay Time | $t_{d(off)}$ | | | 125 | 190 | |
| Fall Time | t_f | | | 60 | 90 | |
| Source-Drain Reverse Recovery Time | t_{rr} | $I_F = 3\ \text{A}$, $dI/dt = 100\ \text{A}/\mu\text{s}$ | | 60 | 90 | |

Notes

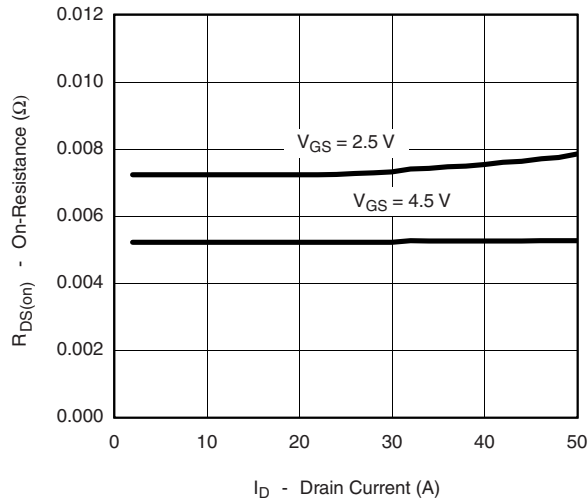
a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.

b. Guaranteed by design, not subject to production testing.

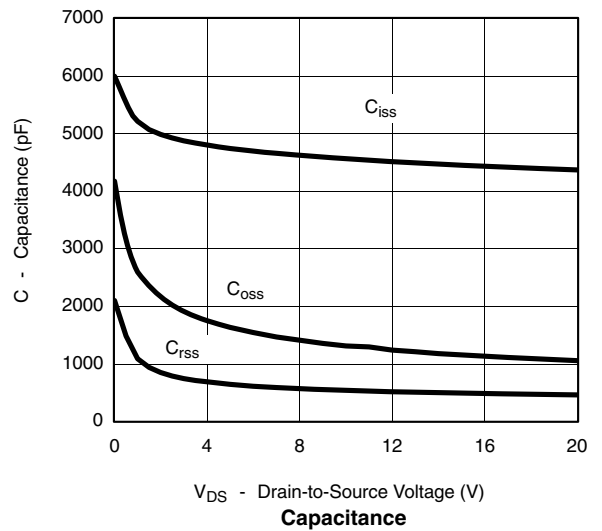
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25°C , unless otherwise noted

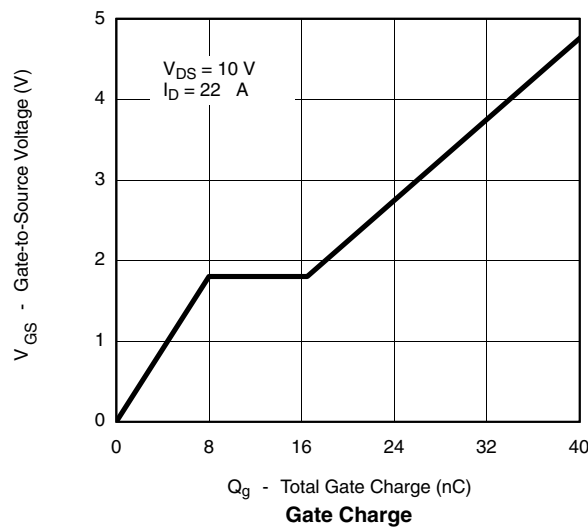
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



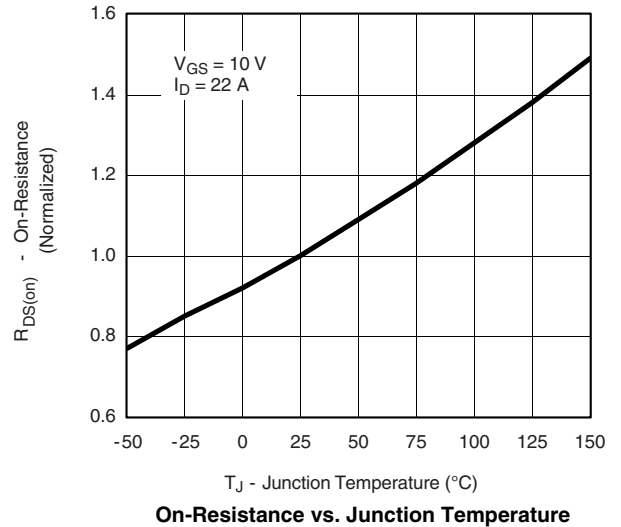
On-Resistance vs. Drain Current



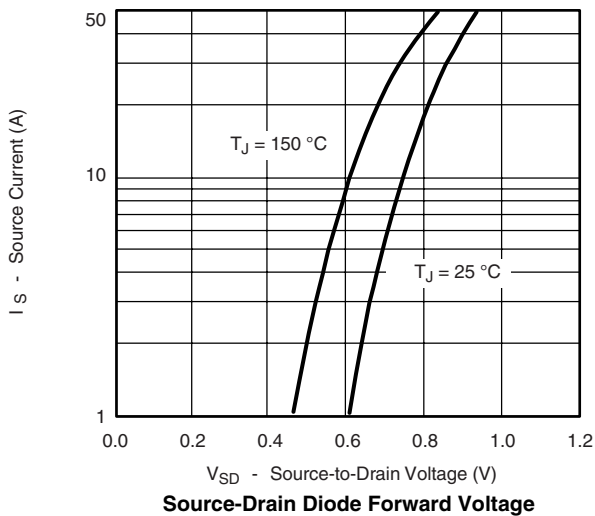
Capacitance



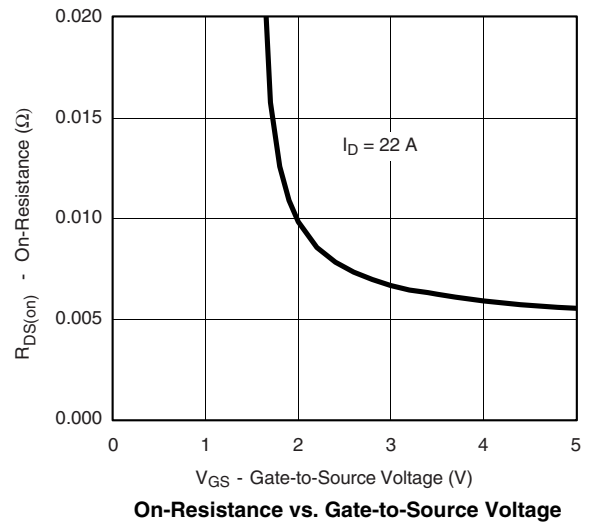
Gate Charge



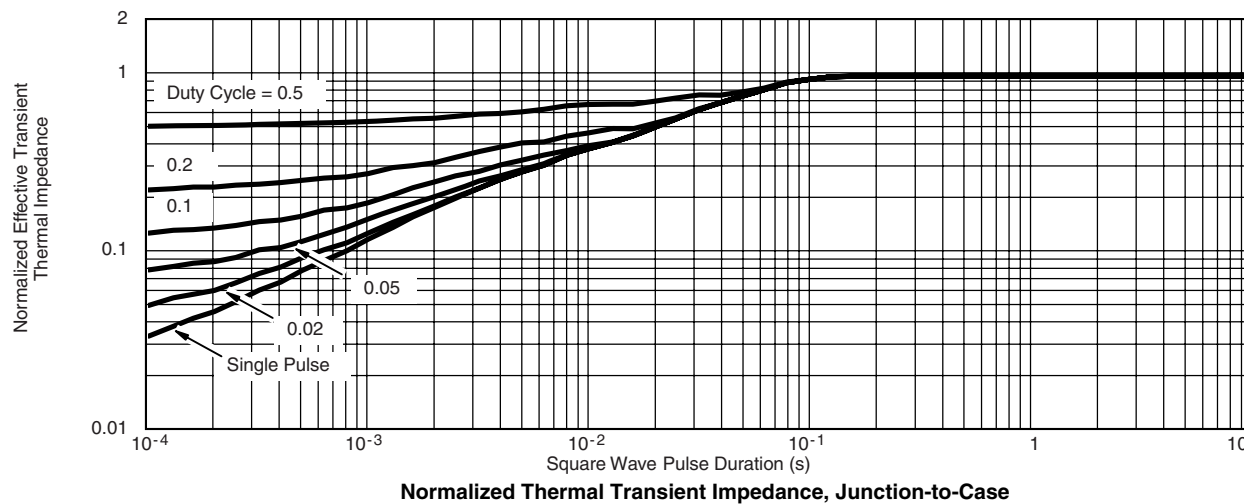
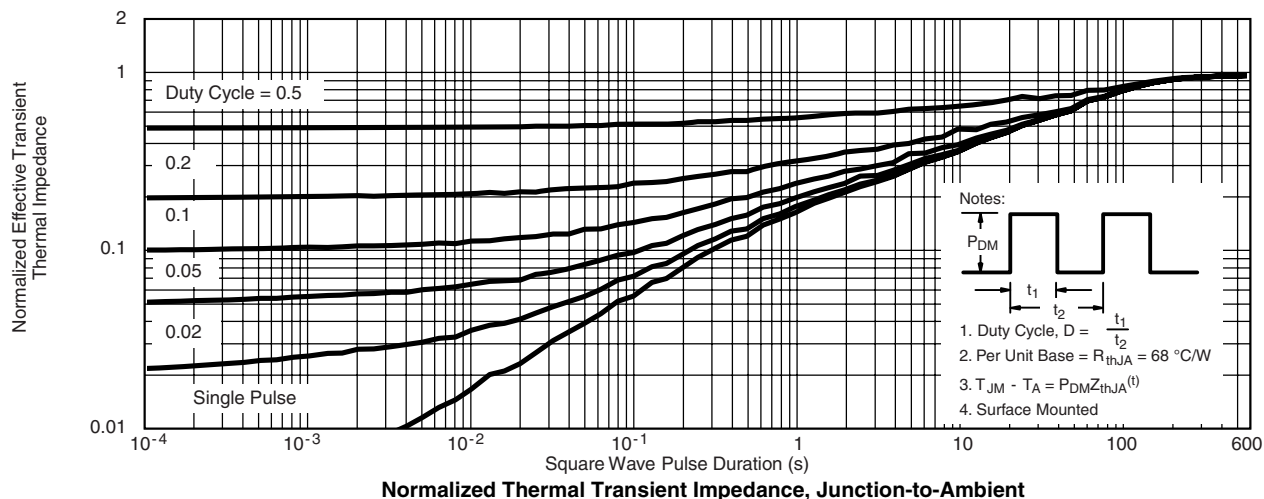
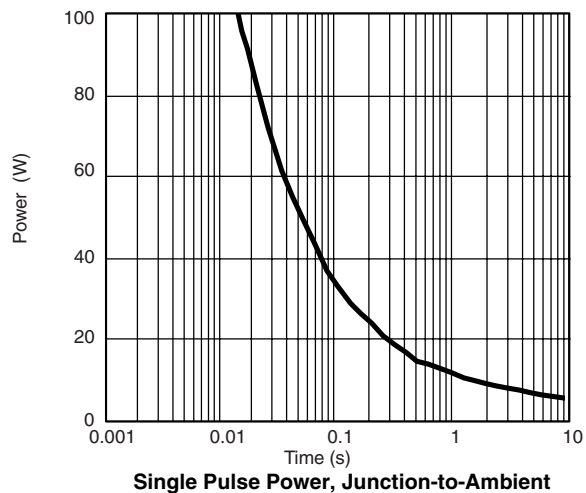
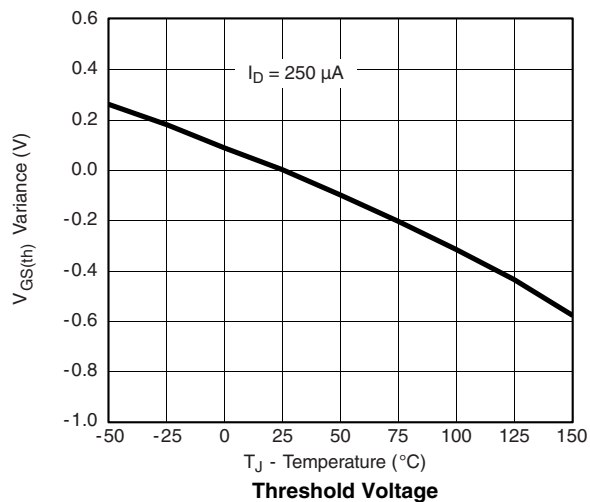
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

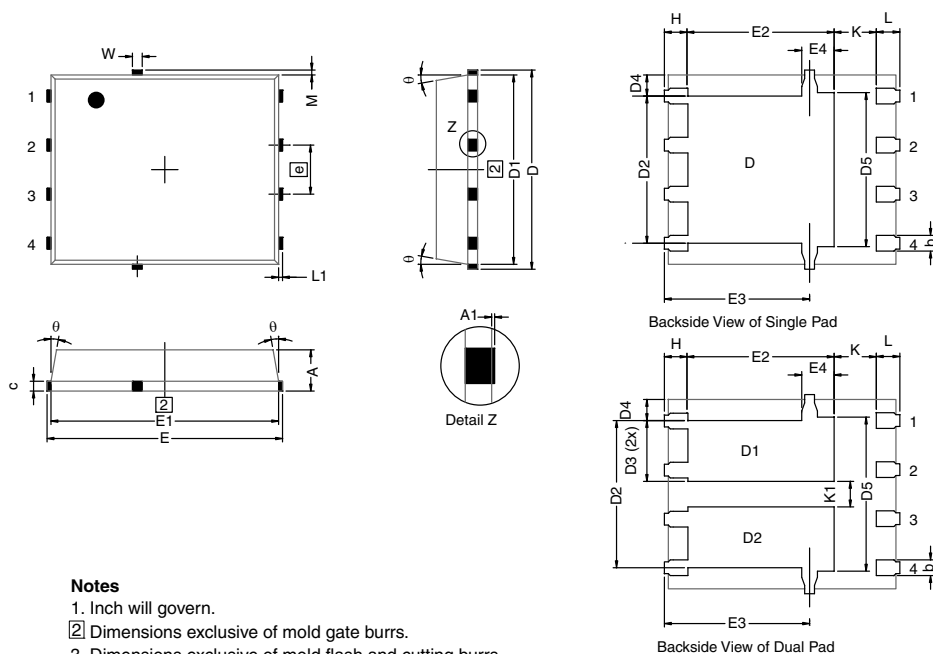


On-Resistance vs. Gate-to-Source Voltage

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

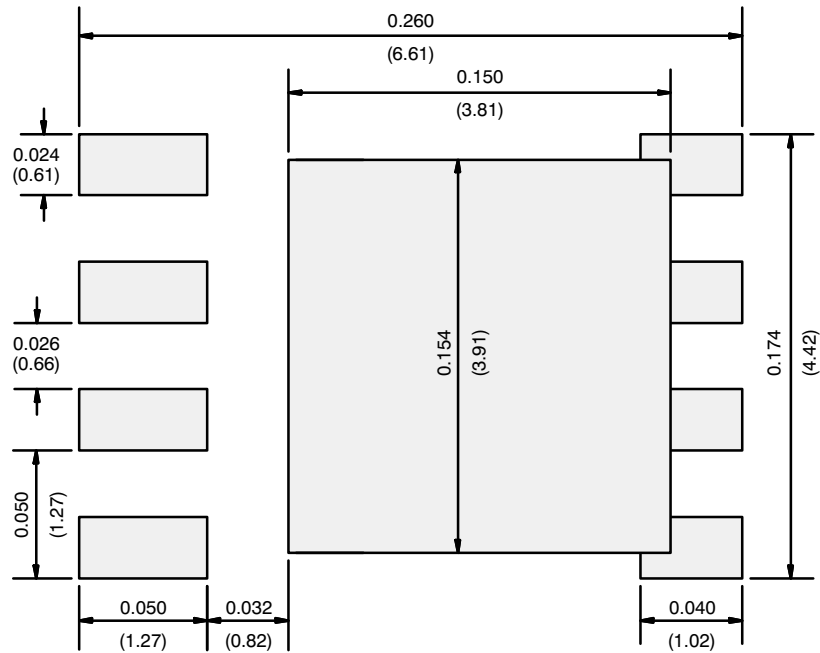
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg71635.

PowerPAK® SO-8, (Single/Dual)



| DIM. | MILLIMETERS | | | INCHES | | |
|---------------------------------|-------------|------|------|-------------|-------|-------|
| | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. |
| A | 0.97 | 1.04 | 1.12 | 0.038 | 0.041 | 0.044 |
| A1 | | - | 0.05 | 0 | - | 0.002 |
| b | 0.33 | 0.41 | 0.51 | 0.013 | 0.016 | 0.020 |
| c | 0.23 | 0.28 | 0.33 | 0.009 | 0.011 | 0.013 |
| D | 5.05 | 5.15 | 5.26 | 0.199 | 0.203 | 0.207 |
| D1 | 4.80 | 4.90 | 5.00 | 0.189 | 0.193 | 0.197 |
| D2 | 3.56 | 3.76 | 3.91 | 0.140 | 0.148 | 0.154 |
| D3 | 1.32 | 1.50 | 1.68 | 0.052 | 0.059 | 0.066 |
| D4 | 0.57 typ. | | | 0.0225 typ. | | |
| D5 | 3.98 typ. | | | 0.157 typ. | | |
| E | 6.05 | 6.15 | 6.25 | 0.238 | 0.242 | 0.246 |
| E1 | 5.79 | 5.89 | 5.99 | 0.228 | 0.232 | 0.236 |
| E2 (for AL product) | 3.30 | 3.48 | 3.66 | 0.130 | 0.137 | 0.144 |
| E2 (for other product) | 3.48 | 3.66 | 3.84 | 0.137 | 0.144 | 0.151 |
| E3 | 3.68 | 3.78 | 3.91 | 0.145 | 0.149 | 0.154 |
| E4 (for AL product) | 0.58 typ. | | | 0.023 typ. | | |
| E4 (for other product) | 0.75 typ. | | | 0.030 typ. | | |
| e | 1.27 BSC | | | 0.050 BSC | | |
| K (for AL product) | 1.45 typ. | | | 0.057 typ. | | |
| K (for other product) | 1.27 typ. | | | 0.050 typ. | | |
| K1 | 0.56 | - | - | 0.022 | - | - |
| H | 0.51 | 0.61 | 0.71 | 0.020 | 0.024 | 0.028 |
| L | 0.51 | 0.61 | 0.71 | 0.020 | 0.024 | 0.028 |
| L1 | 0.06 | 0.13 | 0.20 | 0.002 | 0.005 | 0.008 |
| θ | 0° | - | 12° | 0° | - | 12° |
| W | 0.15 | 0.25 | 0.36 | 0.006 | 0.010 | 0.014 |
| M | 0.125 typ. | | | 0.005 typ. | | |
| ECN: C13-0702-Rev. K, 20-May-13 | | | | | | |
| DWG: 5881 | | | | | | |

RECOMMENDED MINIMUM PADS FOR PowerPAK® SO-8 Single



Recommended Minimum Pads
Dimensions in Inches/(mm)

[Return to Index](#)



Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.